

PATENT 29347/990488

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:	Jeun, et al.)	I hereby certify that this paper is being deposited with the United States Postal Service
Serial No.:	09/677,558)	with sufficient postage as first class mail in an envelope
Filed:	September 29, 2000)	addressed to: Commissioner for Patents, Washington, D.C.
For:	Semiconductor Power Module Having an Electrically Insulating)	20231 on this date:
	Heat Sink and Method of Manufacturing the Same)	December 4, 2001
Docket No.:	29347/990488)))	Mark S. Hauley
Art Unit:	2811)	Mark G. Hanley
)	Registration No. 44,736
Examiner:	D. Nauven)	Attorney for Applicants

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents Washington, D.C. 20231

Sir:

The patent listed on the enclosed PTO Form-1449 is submitted pursuant to 37 CFR §§ 1.56, 1.97, and 1.98. A copy of the patent is enclosed.

Pursuant to 37 C.F.R. § 1.97(c), the \$180 fee set forth in 37 C.F.R. § 1.17(p) for consideration of this Supplemental Information Disclosure Statement is included herewith.

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The Commissioner is authorized to charge any fee deficiency required by this paper, or credit any overpayment, to Deposit Account No. 13-2855. A copy of this paper is enclosed.

Respectfully submitted,

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By:

Mark G. Hanley

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December 4, 2001